Chapter 26

ADC12

The ADC12 module is a high-performance 12-bit analog-to-digital converter (ADC). This chapter describes the ADC12. The ADC12 is implemented in the MSP430x43x MSP430x44x, and MSP430FG461x devices.

Topic **Page**

26.1 ADC12 Introduction

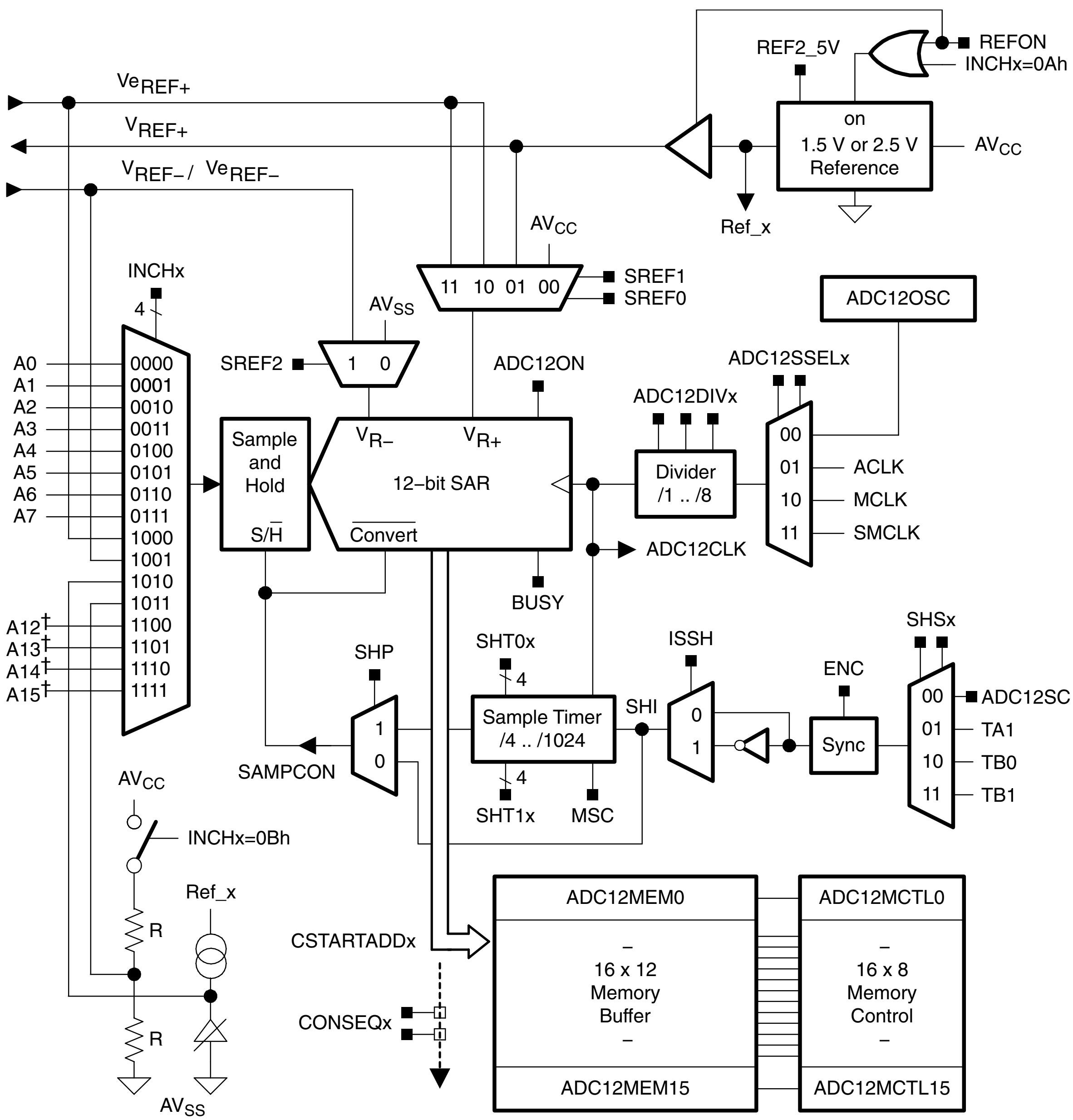
The ADC12 module supports fast, 12-bit analog-to-digital conversions. The module implements a 12-bit SAR core, sample select control, reference generator and a 16 word conversion-and-control buffer. The conversion-and-control buffer allows up to 16 independent ADC samples to be converted and stored without any CPU intervention.

ADC12 features include:

- Greater than 200-ksps maximum conversion rate
- Monotonic 12-bit converter with no missing codes
- Sample-and-hold with programmable sampling periods controlled by software or timers.
- Conversion initiation by software, Timer_A, or Timer_B
- Software selectable on-chip reference voltage generation (1.5 V or 2.5 V)
- Software selectable internal or external reference
- Eight individually configurable external input channels (twelve on MSP430FG43x and MSP430FG461x devices)
- Conversion channels for internal temperature sensor, AV_{CC}, and external references
- Independent channel-selectable reference sources for both positive and negative references
- Selectable conversion clock source
- Single-channel, repeat-single-channel, sequence, and repeat-sequence conversion modes
- ADC core and reference voltage can be powered down separately
- Interrupt vector register for fast decoding of 18 ADC interrupts
- 16 conversion-result storage registers

The block diagram of ADC12 is shown in Figure 26−1.

Figure 26−1. ADC12 Block Diagram



† MSP430FG43x and MSP430FG461x devices only

26.2 ADC12 Operation

The ADC12 module is configured with user software. The setup and operation of the ADC12 is discussed in the following sections.

26.2.1 12-Bit ADC Core

The ADC core converts an analog input to its 12-bit digital representation and stores the result in conversion memory. The core uses two programmable/selectable voltage levels (V_{R+} and V_{R-}) to define the upper and lower limits of the conversion. The digital output (N_{ADC}) is full scale (0FFFh) when the input signal is equal to or higher than V_{R+}, and zero when the input signal is equal to or lower than V_{R-}. The input channel and the reference voltage levels (V_{R+} and V_{R-}) are defined in the conversion-control memory. The conversion formula for the ADC result N_{ADC} is:

$$N_{ADC} = 4095 \times \frac{Vin - V_{R-}}{V_{R+} - V_{R-}}$$

The ADC12 core is configured by two control registers, ADC12CTL0 and ADC12CTL1. The core is enabled with the ADC12ON bit. The ADC12 can be turned off when not in use to save power. With few exceptions the ADC12 control bits can only be modified when ENC = 0. ENC must be set to 1 before any conversion can take place.

Conversion Clock Selection

The ADC12CLK is used both as the conversion clock and to generate the sampling period when the pulse sampling mode is selected. The ADC12 source clock is selected using the ADC12SSELx bits and can be divided by 1 to 8 using the ADC12DIVx bits. Possible ADC12CLK sources are SMCLK, MCLK, ACLK, and an internal oscillator, ADC12OSC.

The ADC12OSC, generated internally, is in the 5-MHz range but varies with individual devices, supply voltage, and temperature. See the device-specific data sheet for the ADC12OSC specification.

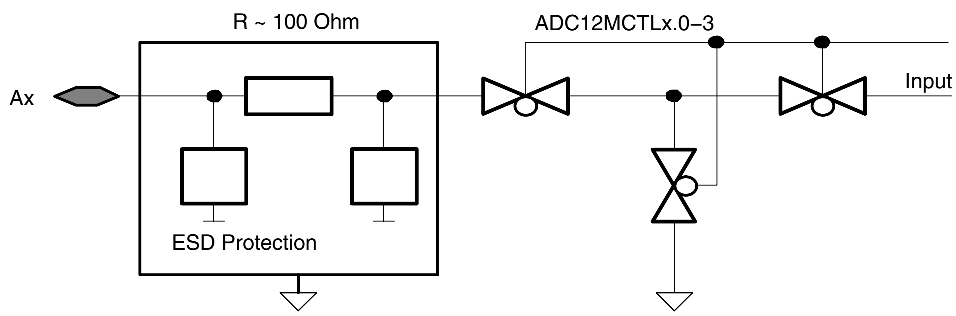
The user must ensure that the clock chosen for ADC12CLK remains active until the end of a conversion. If the clock is removed during a conversion, the operation will not complete and any result will be invalid.

26.2.2 ADC12 Inputs and Multiplexer

The eight external and four internal analog signals are selected as the channel for conversion by the analog input multiplexer. The input multiplexer is a break-before-make type to reduce input-to-input noise injection resulting from channel switching as shown in Figure 26−2. The input multiplexer is also a T-switch to minimize the coupling between channels. Channels that are not selected are isolated from the A/D and the intermediate node is connected to analog ground (AV_{SS}) so that the stray capacitance is grounded to help eliminate crosstalk.

The ADC12 uses the charge redistribution method. When the inputs are internally switched, the switching action may cause transients on the input signal. These transients decay and settle before causing errant conversion.

Figure 26−2. Analog Multiplexer



Analog Port Selection

The ADC12 inputs are multiplexed with the port P6 pins, which are digital CMOS gates. When analog signals are applied to digital CMOS gates, parasitic current can flow from V_{CC} to GND. This parasitic current occurs if the input voltage is near the transition level of the gate. Disabling the port pin buffer eliminates the parasitic current flow and therefore reduces overall current consumption. The P6SELx bits provide the ability to disable the port pin input and output buffers.

```
; P6.0 and P6.1 configured for analog input
      BIS.B  #3h,&P6SEL   ; P6.1 and P6.0 ADC12 function
```

26.2.3 Voltage Reference Generator

The ADC12 module contains a built-in voltage reference with two selectable voltage levels, 1.5 V and 2.5 V. Either of these reference voltages may be used internally and externally on pin V_{REF+}.

Setting REFON=1 enables the internal reference. When REF2_5V = 1, the internal reference is 2.5 V, the reference is 1.5 V when REF2_5V = 0. The reference can be turned off to save power when not in use.

For proper operation the internal voltage reference generator must be supplied with storage capacitance across V_{REF+} and A_{VSS}. The recommended storage capacitance is a parallel combination of 10-µF and 0.1-µF capacitors. From turn-on, a maximum of 17 ms must be allowed for the voltage reference generator to bias the recommended storage capacitors. If the internal reference generator is not used for the conversion, the storage capacitors are not required.

Note: Reference Decoupling

Approximately 200 µA is required from *any* reference used by the ADC12 while the two LSBs are being resolved during a conversion. A parallel combination of 10-µF and 0.1-µF capacitors is recommended for *any* reference used as shown in Figure 26−11.

External references may be supplied for V_{R+} and V_{R-} through pins Ve_{REF+} and V_{REF-}/Ve_{REF-} respectively.

26.2.4 Auto Power-Down

The ADC12 is designed for low power applications. When the ADC12 is not actively converting, the core is automatically disabled and automatically re-enabled when needed. The ADC12OSC is also automatically enabled when needed and disabled when not needed. The reference is not automatically disabled, but can be disabled by setting REFON = 0. When the core, oscillator, or reference are disabled, they consume no current.

26.2.5 Sample and Conversion Timing

An analog-to-digital conversion is initiated with a rising edge of the sample input signal SHI. The source for SHI is selected with the SHSx bits and includes the following:

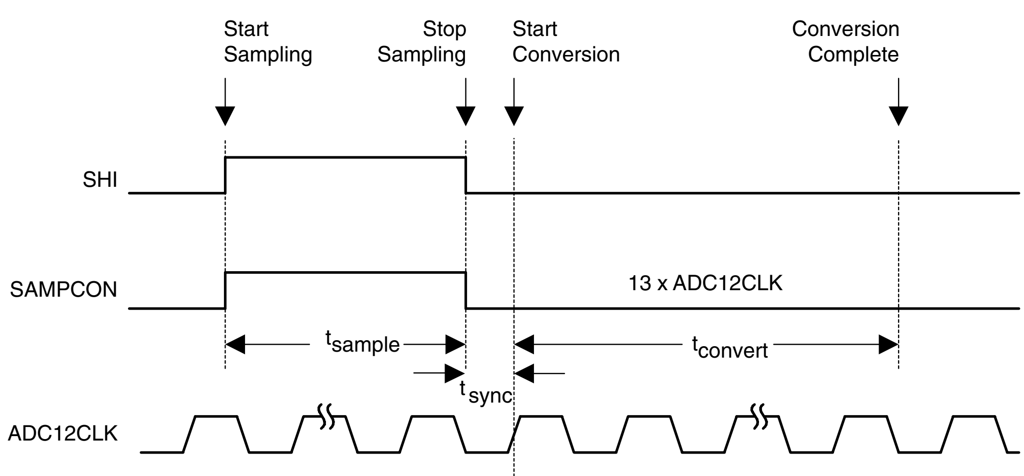
- The ADC12SC bit
- The Timer_A Output Unit 1
- The Timer_B Output Unit 0
- The Timer_B Output Unit 1

The polarity of the SHI signal source can be inverted with the ISSH bit. The SAMPCON signal controls the sample period and start of conversion. When SAMPCON is high, sampling is active. The high-to-low SAMPCON transition starts the analog-to-digital conversion, which requires 13 ADC12CLK cycles. Two different sample-timing methods are defined by control bit SHP, extended sample mode and pulse mode.

Extended Sample Mode

The extended sample mode is selected when SHP = 0. The SHI signal directly controls SAMPCON and defines the length of the sample period $t_{sample.}$ When SAMPCON is high, sampling is active. The high-to-low SAMPCON transition starts the conversion after synchronization with ADC12CLK. See Figure 26–3.

Figure 26–3. Extended Sample Mode

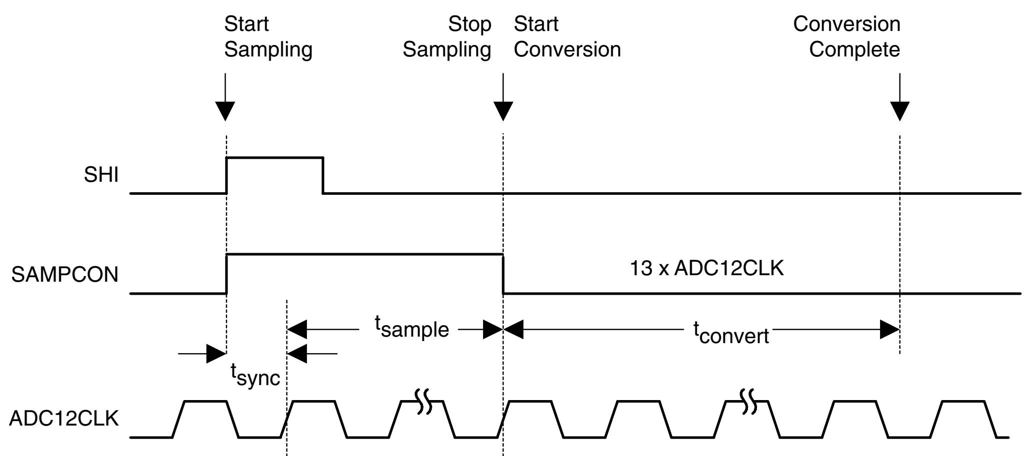


Pulse Sample Mode

The pulse sample mode is selected when SHP = 1. The SHI signal is used to trigger the sampling timer. The SHT0x and SHT1x bits in ADC12CTL0 control the interval of the sampling timer that defines the SAMPCON sample period $t_{sample.}$ The sampling timer keeps SAMPCON high after synchronization with AD12CLK for a programmed interval t_{sample}. The total sampling time is t_{sample} plus t_{sync}. See Figure 26−4.

The SHTx bits select the sampling time in 4x multiples of ADC12CLK. SHT0x selects the sampling time for ADC12MCTL0 to 7 and SHT1x selects the sampling time for ADC12MCTL8 to 15.

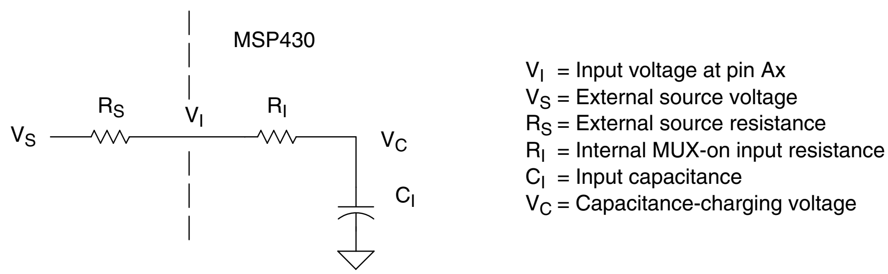
Figure 26−4. Pulse Sample Mode



Sample Timing Considerations

When SAMPCON = 0 all Ax inputs are high impedance. When SAMPCON = 1, the selected Ax input can be modeled as an RC low-pass filter during the sampling time t_{sample}, as shown below in Figure 26−5. An internal MUX-on input resistance R_I (maximum 2 kΩ) in series with capacitor C_I (maximum 40 pF) is seen by the source. The capacitor C_I voltage V_C must be charged to within 1/2 LSB of the source voltage V_S for an accurate 12-bit conversion.

Figure 26−5. Analog Input Equivalent Circuit



The resistance of the source R_S and R_I affect t_{sample}. The following equation can be used to calculate the minimum sampling time t_{sample} for a 12-bit conversion:

$$t_{sample} > (R_S + R_I) \times \ln(2^{13}) \times C_I + 800ns$$

Substituting the values for R_I and C_I given above, the equation becomes:

$$t_{sample} > (R_S + 2k\Omega) \times 9.011 \times 40pF + 800ns$$

For example, if R_S is 10 kΩ, t_{sample} must be greater than 5.13 μs.

26.2.6 Conversion Memory

There are 16 ADC12MEMx conversion memory registers to store conversion results. Each ADC12MEMx is configured with an associated ADC12MCTLx control register. The SREFx bits define the voltage reference and the INCHx bits select the input channel. The EOS bit defines the end of sequence when a sequential conversion mode is used. A sequence rolls over from ADC12MEM15 to ADC12MEM0 when the EOS bit in ADC12MCTL15 is not set.

The CSTARTADDx bits define the first ADC12MCTLx used for any conversion. If the conversion mode is single-channel or repeat-single-channel the CSTARTADDx points to the single ADC12MCTLx to be used.

If the conversion mode selected is either sequence-of-channels or repeat-sequence-of-channels, CSTARTADDx points to the first ADC12MCTLx location to be used in a sequence. A pointer, not visible to software, is incremented automatically to the next ADC12MCTLx in a sequence when each conversion completes. The sequence continues until an EOS bit in ADC12MCTLx is processed - this is the last control byte processed.

When conversion results are written to a selected ADC12MEMx, the corresponding flag in the ADC12IFGx register is set.

26.2.7 ADC12 Conversion Modes

The ADC12 has four operating modes selected by the CONSEQx bits as discussed in Table 26−1.

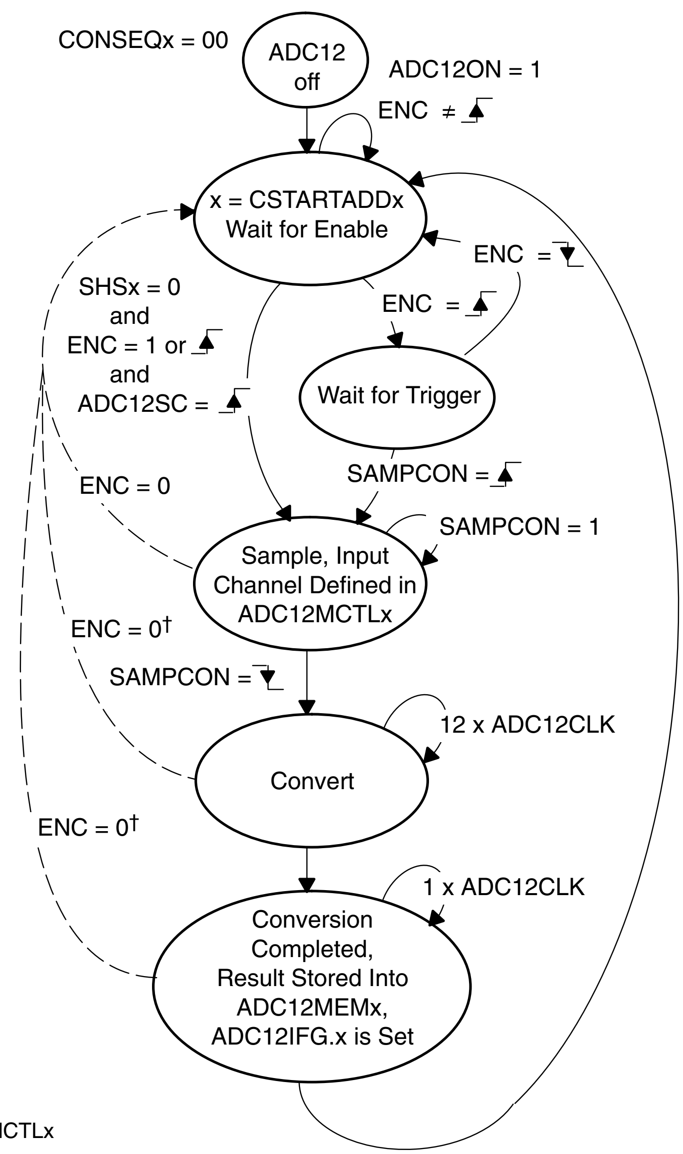
Table 26−1. Conversion Mode Summary

CONSEQx	Mode	Operation
00	Single channel single-conversion	A single channel is converted once.
01	Sequence-of-channels	A sequence of channels is converted once.
10	Repeat-single-channel	A single channel is converted repeatedly.
11	Repeat-sequence-of-channels	A sequence of channels is converted repeatedly.

Single-Channel Single-Conversion Mode

A single channel is sampled and converted once. The ADC result is written to the ADC12MEMx defined by the CSTARTADDx bits. Figure 26−6 shows the flow of the Single-Channel, Single-Conversion mode. When ADC12SC triggers a conversion, successive conversions can be triggered by the ADC12SC bit. When any other trigger source is used, ENC must be toggled between each conversion.

Figure 26−6. Single-Channel, Single-Conversion Mode



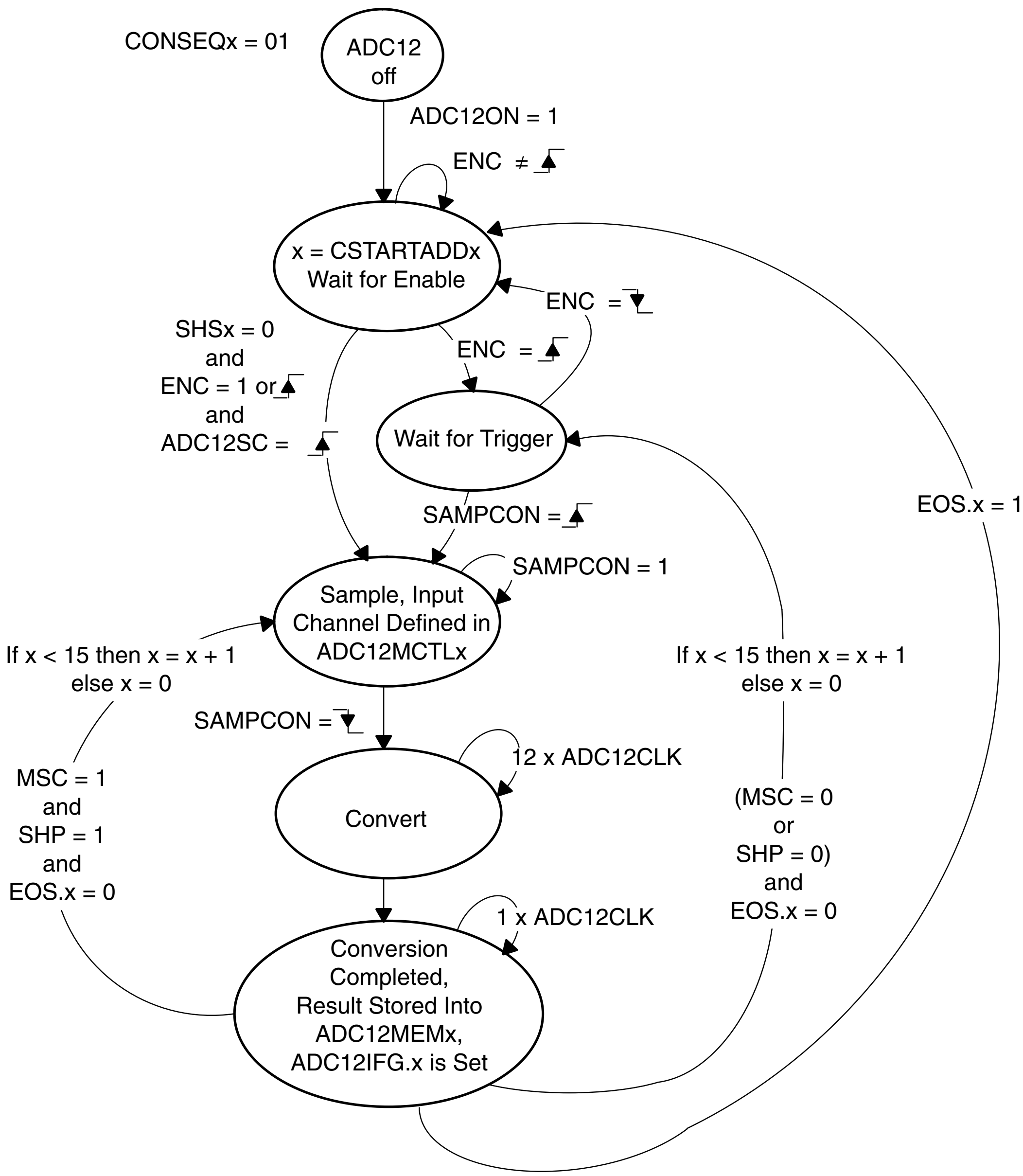
x = pointer to ADC12MCTLx

†Conversion result is unpredictable

Sequence-of-Channels Mode

A sequence of channels is sampled and converted once. The ADC results are written to the conversion memories starting with the ADCMEMx defined by the CSTARTADDx bits. The sequence stops after the measurement of the channel with a set EOS bit. Figure 26−7 shows the sequence-of-channels mode. When ADC12SC triggers a sequence, successive sequences can be triggered by the ADC12SC bit. When any other trigger source is used, ENC must be toggled between each sequence.

Figure 26−7. Sequence-of-Channels Mode

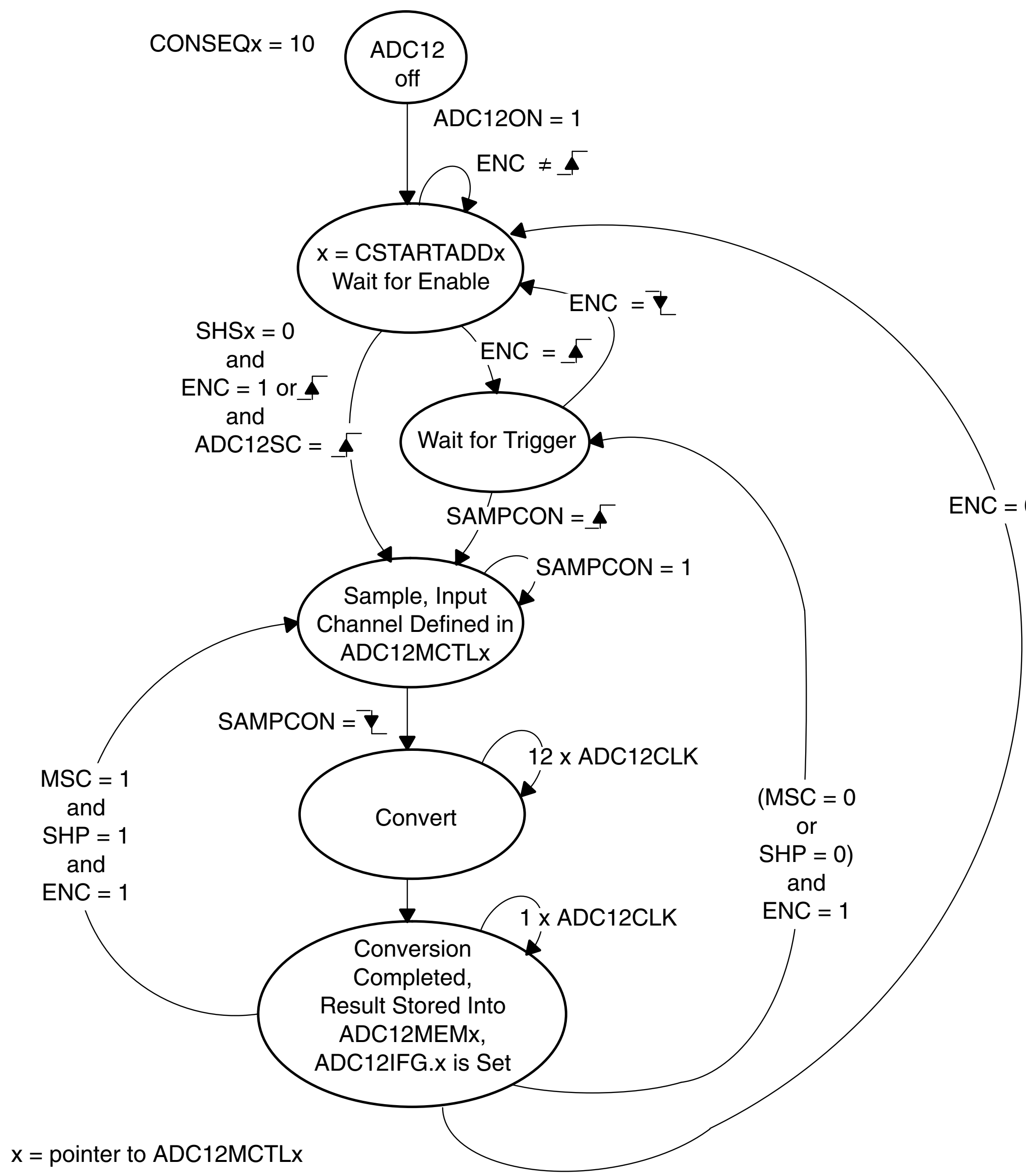


x = pointer to ADC12MCTLx

Repeat-Single-Channel Mode

A single channel is sampled and converted continuously. The ADC results are written to the ADC12MEMx defined by the CSTARTADDx bits. It is necessary to read the result after the completed conversion because only one ADC12MEMx memory is used and is overwritten by the next conversion. Figure 26−8 shows repeat-single-channel mode

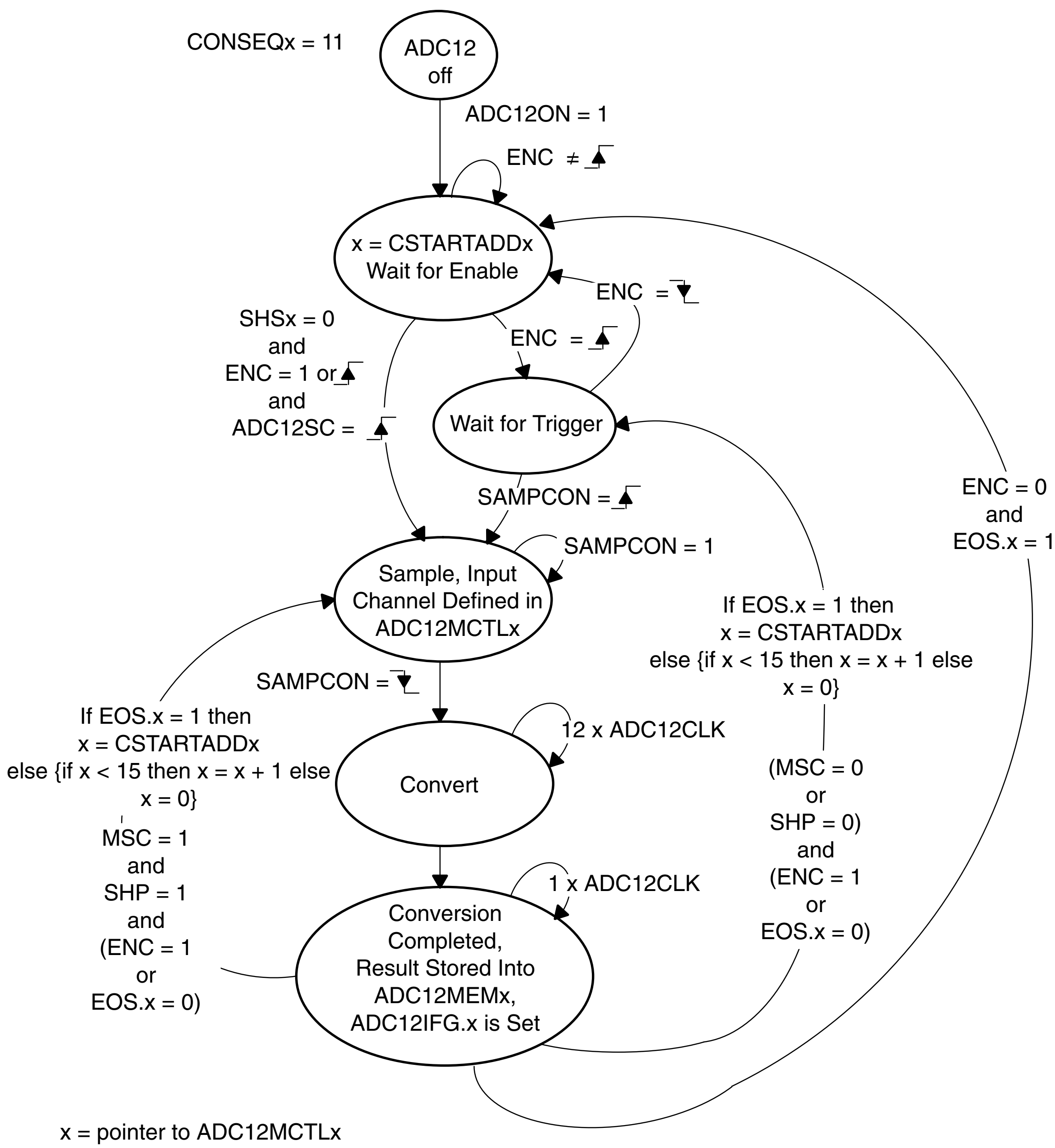
Figure 26−8. Repeat-Single-Channel Mode



Repeat-Sequence-of-Channels Mode

A sequence of channels is sampled and converted repeatedly. The ADC results are written to the conversion memories starting with the ADC12MEMx defined by the CSTARTADDx bits. The sequence ends after the measurement of the channel with a set EOS bit and the next trigger signal re-starts the sequence. Figure 26−9 shows the repeat-sequence-of-channels mode.

Figure 26−9. Repeat-Sequence-of-Channels Mode



Using the Multiple Sample and Convert (MSC) Bit

To configure the converter to perform successive conversions automatically and as quickly as possible, a multiple sample and convert function is available. When MSC = 1, CONSEQx > 0, and the sample timer is used, the first rising edge of the SHI signal triggers the first conversion. Successive conversions are triggered automatically as soon as the prior conversion is completed. Additional rising edges on SHI are ignored until the sequence is completed in the single-sequence mode or until the ENC bit is toggled in repeat-single-channel, or repeated-sequence modes. The function of the ENC bit is unchanged when using the MSC bit.

Stopping Conversions

Stopping ADC12 activity depends on the mode of operation. The recommended ways to stop an active conversion or conversion sequence are:

- Resetting ENC in single-channel single-conversion mode stops a conversion immediately and the results are unpredictable. For correct results, poll the busy bit until reset before clearing ENC.
- Resetting ENC during repeat-single-channel operation stops the converter at the end of the current conversion.
- Resetting ENC during a sequence or repeat-sequence mode stops the converter at the end of the sequence.
- Any conversion mode may be stopped immediately by setting the CONSEQx = 0 and resetting ENC bit. Conversion data are unreliable.

Note: No EOS Bit Set For Sequence

If no EOS bit is set and a sequence mode is selected, resetting the ENC bit does not stop the sequence. To stop the sequence, first select a single-channel mode and then reset ENC.

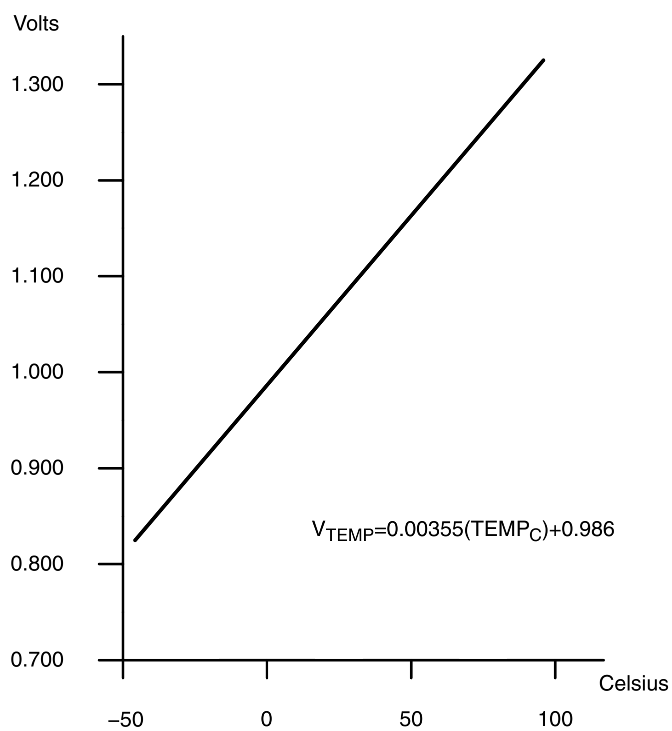
26.2.8 Using the Integrated Temperature Sensor

To use the on-chip temperature sensor, the user selects the analog input channel INCHx = 1010. Any other configuration is done as if an external channel was selected, including reference selection, conversion-memory selection, etc.

The typical temperature sensor transfer function is shown in Figure 26−10. When using the temperature sensor, the sample period must be greater than 30 µs. The temperature sensor offset error can be large, and may need to be calibrated for most applications. See device-specific data sheet for parameters.

Selecting the temperature sensor automatically turns on the on-chip reference generator as a voltage source for the temperature sensor. However, it does not enable the V_{REF+} output or affect the reference selections for the conversion. The reference choices for converting the temperature sensor are the same as with any other channel.

Figure 26−10. Typical Temperature Sensor Transfer Function



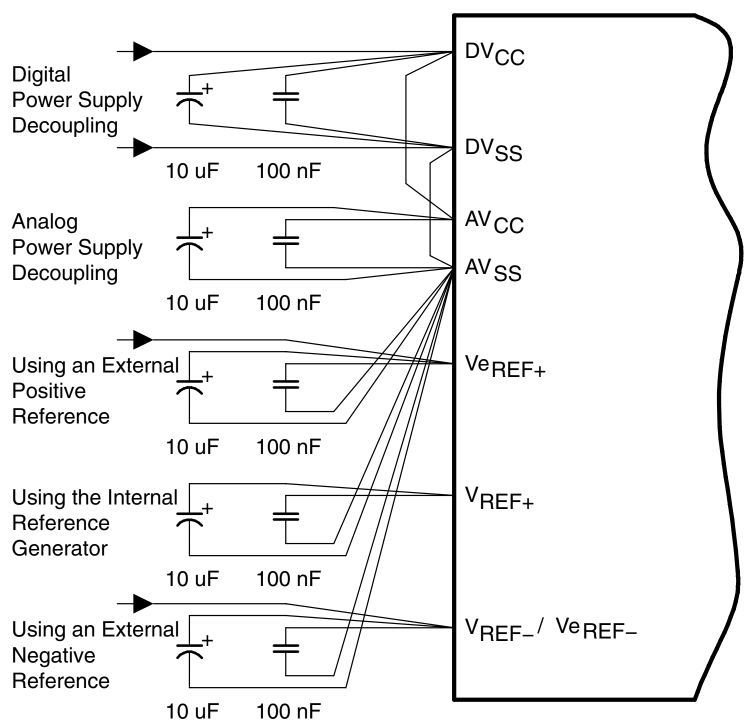
26.2.9 ADC12 Grounding and Noise Considerations

As with any high-resolution ADC, appropriate printed-circuit-board layout and grounding techniques should be followed to eliminate ground loops, unwanted parasitic effects, and noise.

Ground loops are formed when return current from the A/D flows through paths that are common with other analog or digital circuitry. If care is not taken, this current can generate small, unwanted offset voltages that can add to or subtract from the reference or input voltages of the A/D converter. The connections shown in Figure 26−11 help avoid this.

In addition to grounding, ripple and noise spikes on the power supply lines due to digital switching or switching power supplies can corrupt the conversion result. A noise-free design using separate analog and digital ground planes with a single-point connection is recommend to achieve high accuracy.

Figure 26−11. ADC12 Grounding and Noise Considerations



26.2.10 ADC12 Interrupts

The ADC12 has 18 interrupt sources:

- ADC12IFG0-ADC12IFG15
- ADC12OV, ADC12MEMx overflow
- ADC12TOV, ADC12 conversion time overflow

The ADC12IFGx bits are set when their corresponding ADC12MEMx memory register is loaded with a conversion result. An interrupt request is generated if the corresponding ADC12IEx bit and the GIE bit are set. The ADC12OV condition occurs when a conversion result is written to any ADC12MEMx before its previous conversion result was read. The ADC12TOV condition is generated when another sample-and-conversion is requested before the current conversion is completed. The DMA is triggered after the conversion in single channel modes or after the completion of a sequence–of–channel modes.

ADC12IV, Interrupt Vector Generator

All ADC12 interrupt sources are prioritized and combined to source a single interrupt vector. The interrupt vector register ADC12IV is used to determine which enabled ADC12 interrupt source requested an interrupt.

The highest priority enabled ADC12 interrupt generates a number in the ADC12IV register (see register description). This number can be evaluated or added to the program counter to automatically enter the appropriate software routine. Disabled ADC12 interrupts do not affect the ADC12IV value.

Any access, read or write, of the ADC12IV register automatically resets the ADC12OV condition or the ADC12TOV condition if either was the highest pending interrupt. Neither interrupt condition has an accessible interrupt flag. The ADC12IFGx flags are not reset by an ADC12IV access. ADC12IFGx bits are reset automatically by accessing their associated ADC12MEMx register or may be reset with software.

If another interrupt is pending after servicing of an interrupt, another interrupt is generated. For example, if the ADC12OV and ADC12IFG3 interrupts are pending when the interrupt service routine accesses the ADC12IV register, the ADC12OV interrupt condition is reset automatically. After the RETI instruction of the interrupt service routine is executed, the ADC12IFG3 generates another interrupt.

ADC12 Interrupt Handling Software Example

The following software example shows the recommended use of ADC12IV and the handling overhead. The ADC12IV value is added to the PC to automatically jump to the appropriate routine.

The numbers at the right margin show the necessary CPU cycles for each instruction. The software overhead for different interrupt sources includes interrupt latency and return-from-interrupt cycles, but not the task handling itself. The latencies are:

- ❑ ADC12IFG0 - ADC12IFG14, ADC12TOV and ADC12OV 16 cycles
- ❑ ADC12IFG15 14 cycles

The interrupt handler for ADC12IFG15 shows a way to check immediately if a higher prioritized interrupt occurred during the processing of ADC12IFG15. This saves nine cycles if another ADC12 interrupt is pending.

```
; Interrupt handler for ADC12.
INT_ADC12          ; Enter Interrupt Service Routine     6
   ADD   &ADC12IV,PC; Add offset to PC                   3
   RETI            ; Vector 0: No interrupt              5
   JMP   ADOV      ; Vector 2: ADC overflow              2
   JMP   ADTOV     ; Vector 4: ADC timing overflow       2
   JMP   ADM0      ; Vector 6: ADC12IFG0                 2
      ...          ; Vectors 8-32                        2
   JMP   ADM14     ; Vector 34: ADC12IFG14               2
;
; Handler for ADC12IFG15 starts here. No JMP required.
;
ADM15    MOV  &ADC12MEM15,xxx; Move result, flag is reset
         ...                 ; Other instruction needed?
         JMP  INT_ADC12      ; Check other int pending
;
;  ADC12IFG14-ADC12IFG1 handlers go here
;
ADM0     MOV  &ADC12MEM0,xxx ; Move result, flag is reset
         ...                 ; Other instruction needed?
         RETI                ; Return                    5
;
ADTOV     ...                ; Handle Conv. time overflow
          RETI               ; Return                    5
;
ADOV      ...                ; Handle ADCMEMx overflow
          RETI               ; Return                    5
```

26.3 ADC12 Registers

The ADC12 registers are listed in Table 26−2 .

Table 26−2.ADC12 Registers

Register	Short Form	Register Type	Address	Initial State
ADC12 control register 0	ADC12CTL0	Read/write	01A0h	Reset with POR
ADC12 control register 1	ADC12CTL1	Read/write	01A2h	Reset with POR
ADC12 interrupt flag register	ADC12IFG	Read/write	01A4h	Reset with POR
ADC12 interrupt enable register	ADC12IE	Read/write	01A6h	Reset with POR
ADC12 interrupt vector word	ADC12IV	Read	01A8h	Reset with POR
ADC12 memory 0	ADC12MEM0	Read/write	0140h	Unchanged
ADC12 memory 1	ADC12MEM1	Read/write	0142h	Unchanged
ADC12 memory 2	ADC12MEM2	Read/write	0144h	Unchanged
ADC12 memory 3	ADC12MEM3	Read/write	0146h	Unchanged
ADC12 memory 4	ADC12MEM4	Read/write	0148h	Unchanged
ADC12 memory 5	ADC12MEM5	Read/write	014Ah	Unchanged
ADC12 memory 6	ADC12MEM6	Read/write	014Ch	Unchanged
ADC12 memory 7	ADC12MEM7	Read/write	014Eh	Unchanged
ADC12 memory 8	ADC12MEM8	Read/write	0150h	Unchanged
ADC12 memory 9	ADC12MEM9	Read/write	0152h	Unchanged
ADC12 memory 10	ADC12MEM10	Read/write	0154h	Unchanged
ADC12 memory 11	ADC12MEM11	Read/write	0156h	Unchanged
ADC12 memory 12	ADC12MEM12	Read/write	0158h	Unchanged
ADC12 memory 13	ADC12MEM13	Read/write	015Ah	Unchanged
ADC12 memory 14	ADC12MEM14	Read/write	015Ch	Unchanged
ADC12 memory 15	ADC12MEM15	Read/write	015Eh	Unchanged
ADC12 memory control 0	ADC12MCTL0	Read/write	080h	Reset with POR
ADC12 memory control 1	ADC12MCTL1	Read/write	081h	Reset with POR
ADC12 memory control 2	ADC12MCTL2	Read/write	082h	Reset with POR
ADC12 memory control 3	ADC12MCTL3	Read/write	083h	Reset with POR
ADC12 memory control 4	ADC12MCTL4	Read/write	084h	Reset with POR
ADC12 memory control 5	ADC12MCTL5	Read/write	085h	Reset with POR
ADC12 memory control 6	ADC12MCTL6	Read/write	086h	Reset with POR
ADC12 memory control 7	ADC12MCTL7	Read/write	087h	Reset with POR
ADC12 memory control 8	ADC12MCTL8	Read/write	088h	Reset with POR
ADC12 memory control 9	ADC12MCTL9	Read/write	089h	Reset with POR
ADC12 memory control 10	ADC12MCTL10	Read/write	08Ah	Reset with POR
ADC12 memory control 11	ADC12MCTL11	Read/write	08Bh	Reset with POR
ADC12 memory control 12	ADC12MCTL12	Read/write	08Ch	Reset with POR
ADC12 memory control 13	ADC12MCTL13	Read/write	08Dh	Reset with POR
ADC12 memory control 14	ADC12MCTL14	Read/write	08Eh	Reset with POR
ADC12 memory control 15	ADC12MCTL15	Read/write	08Fh	Reset with POR

ADC12CTL0, ADC12 Control Register 0

15	14	13	12	11	10	9	8
SHT1x				SHT0x			
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

7	6	5	4	3	2	1	0
MSC	REF2_5V	REFON	ADC12ON	ADC12OVIE	ADC12 TOVIE	ENC	ADC12SC
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

(Shaded) Modifiable only when ENC = 0

SHT1x Bits 15-12 Sample-and-hold time. These bits define the number of ADC12CLK cycles in the sampling period for registers ADC12MEM8 to ADC12MEM15.

SHT0x Bits 11-8 Sample-and-hold time. These bits define the number of ADC12CLK cycles in the sampling period for registers ADC12MEM0 to ADC12MEM7.

SHTx Bits	ADC12CLK cycles
0000	4
0001	8
0010	16
0011	32
0100	64
0101	96
0110	128
0111	192
1000	256
1001	384
1010	512
1011	768
1100	1024
1101	1024
1110	1024
1111	1024

MSC	Bit 7	Multiple sample and conversion. Valid only for sequence or repeated modes. 0 The sampling timer requires a rising edge of the SHI signal to trigger each sample-and-conversion. 1 The first rising edge of the SHI signal triggers the sampling timer, but further sample-and-conversions are performed automatically as soon as the prior conversion is completed.
REF2_5V	Bit 6	Reference generator voltage. REFON must also be set. 0 1.5 V 1 2.5 V
REFON	Bit 5	Reference generator on 0 Reference off 1 Reference on
ADC12ON	Bit 4	ADC12 on 0 ADC12 off 1 ADC12 on
ADC12OVIE	Bit 3	ADC12MEMx overflow-interrupt enable. The GIE bit must also be set to enable the interrupt. 0 Overflow interrupt disabled 1 Overflow interrupt enabled
ADC12 TOVIE	Bit 2	ADC12 conversion-time-overflow interrupt enable. The GIE bit must also be set to enable the interrupt. 0 Conversion time overflow interrupt disabled 1 Conversion time overflow interrupt enabled
ENC	Bit 1	Enable conversion 0 ADC12 disabled 1 ADC12 enabled
ADC12SC	Bit 0	Start conversion. Software-controlled sample-and-conversion start. ADC12SC and ENC may be set together with one instruction. ADC12SC is reset automatically. 0 No sample-and-conversion-start 1 Start sample-and-conversion

ADC12CTL1, ADC12 Control Register 1

15	14	13	12	11	10	9	8
CSTARTADDx				SHSx		SHP	ISSH
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

7	6	5	4	3	2	1	0
ADC12DIVx			ADC12SSELx		CONSEQx		ADC12 BUSY
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	r–(0)

(shaded) Modifiable only when ENC = 0

CSTART ADDx	Bits 15-12	Conversion start address. These bits select which ADC12 conversion-memory register is used for a single conversion or for the first conversion in a sequence. The value of CSTARTADDx is 0 to 0Fh, corresponding to ADC12MEM0 to ADC12MEM15.
SHSx	Bits 11-10	Sample-and-hold source select 00 ADC12SC bit 01 Timer_A.OUT1 10 Timer_B.OUT0 11 Timer_B.OUT1
SHP	Bit 9	Sample-and-hold pulse-mode select. This bit selects the source of the sampling signal (SAMPCON) to be either the output of the sampling timer or the sample-input signal directly. 0 SAMPCON signal is sourced from the sample-input signal. 1 SAMPCON signal is sourced from the sampling timer.
ISSH	Bit 8	Invert signal sample-and-hold 0 The sample-input signal is not inverted. 1 The sample-input signal is inverted.
ADC12DIVx	Bits 7-5	ADC12 clock divider 000 /1 001 /2 010 /3 011 /4 100 /5 101 /6 110 /7 111 /8

ADC12 SSELx	Bits 4-3	ADC12 clock source select 00 ADC12OSC 01 ACLK 10 MCLK 11 SMCLK
CONSEQx	Bits 2-1	Conversion sequence mode select 00 Single-channel, single-conversion 01 Sequence-of-channels 10 Repeat-single-channel 11 Repeat-sequence-of-channels
ADC12 BUSY	Bit 0	ADC12 busy. This bit indicates an active sample or conversion operation. 0 No operation is active. 1 A sequence, sample, or conversion is active.

ADC12MEMx, ADC12 Conversion Memory Registers

15	14	13	12	11	10	9	8
0	**0**	**0**	**0**	**Conversion Results**			
r0	r0	r0	r0	rw	rw	rw	rw

7	6	5	4	3	2	1	0
Conversion Results							
rw	rw	rw	rw	rw	rw	rw	rw

Conversion Results	Bits 15-0	The 12-bit conversion results are right-justified. Bit 11 is the MSB. Bits 15-12 are always 0. Writing to the conversion memory registers will corrupt the results.

ADC12MCTLx, ADC12 Conversion Memory Control Registers

7	6	5	4	3	2	1	0
EOS	**SREFx**			**INCHx**			
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

(shaded box) Modifiable only when ENC = 0

EOS Bit 7 End of sequence. Indicates the last conversion in a sequence.
- 0 Not end of sequence
- 1 End of sequence

SREFx Bits 6-4 Select reference
- 000 V_{R+} = AV_{CC} and V_{R-} = AV_{SS}
- 001 V_{R+} = V_{REF+} and V_{R-} = AV_{SS}
- 010 V_{R+} = Ve_{REF+} and V_{R-} = AV_{SS}
- 011 V_{R+} = Ve_{REF+} and V_{R-} = AV_{SS}
- 100 V_{R+} = AV_{CC} and V_{R-} = V_{REF-}/ Ve_{REF-}
- 101 V_{R+} = V_{REF+} and V_{R-} = V_{REF-}/ Ve_{REF-}
- 110 V_{R+} = Ve_{REF+} and V_{R-} = V_{REF-}/ Ve_{REF-}
- 111 V_{R+} = Ve_{REF+} and V_{R-} = V_{REF-}/ Ve_{REF-}

INCHx Bits 3-0 Input channel select
- 0000 A0
- 0001 A1
- 0010 A2
- 0011 A3
- 0100 A4
- 0101 A5
- 0110 A6
- 0111 A7
- 1000 Ve_{REF+}
- 1001 V_{REF-}/Ve_{REF-}
- 1010 Temperature sensor
- 1011 (AV_{CC} – AV_{SS}) / 2
- 1100 (AV_{CC} – AV_{SS}) / 2, A12 on ’FG43x and ’FG461x devices
- 1101 (AV_{CC} – AV_{SS}) / 2, A13 on ’FG43x and ’FG461x devices
- 1110 (AV_{CC} – AV_{SS}) / 2, A14 on ’FG43x and ’FG461x devices
- 1111 (AV_{CC} – AV_{SS}) / 2, A15 on ’FG43x and ’FG461x devices

ADC12IE, ADC12 Interrupt Enable Register

15	14	13	12	11	10	9	8
ADC12IE15	**ADC12IE14**	**ADC12IE13**	**ADC12IE12**	**ADC12IE11**	**ADC12IE10**	**ADC12IE9**	**ADC12IE8**
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

7	6	5	4	3	2	1	0
ADC12IE7	**ADC12IE6**	**ADC12IE5**	**ADC12IE4**	**ADC12IE3**	**ADC12IE2**	**ADC12IE1**	**ADC12IE0**
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

ADC12IEx Bits 15-0 Interrupt enable. These bits enable or disable the interrupt request for the ADC12IFGx bits.
- 0 Interrupt disabled
- 1 Interrupt enabled

ADC12IFG, ADC12 Interrupt Flag Register

15	14	13	12	11	10	9	8
ADC12 IFG15	**ADC12 IFG14**	**ADC12 IFG13**	**ADC12 IFG12**	**ADC12 IFG11**	**ADC12 IFG10**	**ADC12 IFG9**	**ADC12 IFG8**
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

7	6	5	4	3	2	1	0
ADC12 IFG7	**ADC12 IFG6**	**ADC12 IFG5**	**ADC12 IFG4**	**ADC12 IFG3**	**ADC12 IFG2**	**ADC12 IFG1**	**ADC12 IFG0**
rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)	rw–(0)

ADC12IFGx Bits 15-0 ADC12MEMx Interrupt flag. These bits are set when corresponding ADC12MEMx is loaded with a conversion result. The ADC12IFGx bits are reset if the corresponding ADC12MEMx is accessed, or may be reset with software.
- 0 No interrupt pending
- 1 Interrupt pending

ADC12IV, ADC12 Interrupt Vector Register

15	14	13	12	11	10	9	8
0	**0**	**0**	**0**	**0**	**0**	**0**	**0**
r0	r0	r0	r0	r0	r0	r0	r0

7	6	5	4	3	2	1	0
0	**0**	**ADC12IVx**					**0**
r0	r0	r–(0)	r–(0)	r–(0)	r–(0)	r–(0)	r0

ADC12IVx Bits 15-0 ADC12 interrupt vector value

ADC12IV Contents	Interrupt Source	Interrupt Flag	Interrupt Priority
000h	No interrupt pending	–	
002h	ADC12MEMx overflow	–	Highest
004h	Conversion time overflow	–	
006h	ADC12MEM0 interrupt flag	ADC12IFG0	
008h	ADC12MEM1 interrupt flag	ADC12IFG1	
00Ah	ADC12MEM2 interrupt flag	ADC12IFG2	
00Ch	ADC12MEM3 interrupt flag	ADC12IFG3	
00Eh	ADC12MEM4 interrupt flag	ADC12IFG4	
010h	ADC12MEM5 interrupt flag	ADC12IFG5	
012h	ADC12MEM6 interrupt flag	ADC12IFG6	
014h	ADC12MEM7 interrupt flag	ADC12IFG7	
016h	ADC12MEM8 interrupt flag	ADC12IFG8	
018h	ADC12MEM9 interrupt flag	ADC12IFG9	
01Ah	ADC12MEM10 interrupt flag	ADC12IFG10	
01Ch	ADC12MEM11 interrupt flag	ADC12IFG11	
01Eh	ADC12MEM12 interrupt flag	ADC12IFG12	
020h	ADC12MEM13 interrupt flag	ADC12IFG13	
022h	ADC12MEM14 interrupt flag	ADC12IFG14	
024h	ADC12MEM15 interrupt flag	ADC12IFG15	Lowest